



IEC 61158-2

Edition 4.0 2007-12

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



Industrial communication networks – Fieldbus specifications –  
Part 2: Physical layer specification and service definition

Réseaux de communications industriels – Spécifications des bus de terrain –  
Partie 2: Spécification de couche physique et définition des services

<https://standards.iteh.ai/curl/pg/standards/iec/3d85c882-93df-4a29-bcfa-fc59e8d67807/iec-61158-2-2007>



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INTERNATIONAL  
ELECTROTECHNICAL  
COMMISSION

COMMISSION  
ELECTROTECHNIQUE  
INTERNATIONALE

PRICE CODE  
CODE PRIX XH

ICS 25.040, 35.100, 35.240.50

ISBN 978-2-8322-1342-1

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